

# MOS FIELD EFFECT TRANSISTOR $\mu$ PA1870B

### N-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

#### **DESCRIPTION**

The  $\mu$ PA1870B is a switching device which can be driven directly by a 2.5 V power source.

The  $\mu$ PA1870B features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

#### **FEATURES**

- 2.5 V drive available
- · Low on-state resistance

RDS(on)1 = 16.0 m $\Omega$  TYP. (VGS = 4.5 V, ID = 3.0 A)

RDS(on)2 = 16.5 m $\Omega$  TYP. (VGS = 4.0 V, ID = 3.0 A)

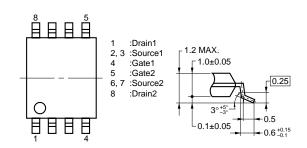
RDS(on)3 = 20.0 m $\Omega$  TYP. (VGS = 2.5 V, ID = 3.0 A)

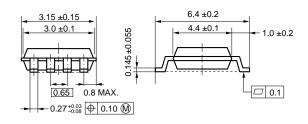
• Built-in G-S protection diode against ESD

#### ORDERING INFORMATION

PART NUMBER	PACKAGE
μPA1870BGR-9JG	Power TSSOP8

#### PACKAGE DRAWING (Unit: mm)





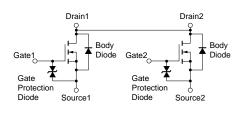
#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vgs = 0 V)	VDSS	20.0	V
Gate to Source Voltage (Vps = 0 V)	Vgss	±12.0	V
Drain Current (DC) Note 1	ID(DC)	±6.0	Α
Drain Current (pulse) Note 2	D(pulse)	±80.0	Α
Total Power Dissipation Note 1	Рт	2.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C

**Notes 1.** Mounted on ceramic substrate of 50 cm<sup>2</sup> x 1.1 mm

**2.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

#### **EQUIVALENT CIRCUIT**



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

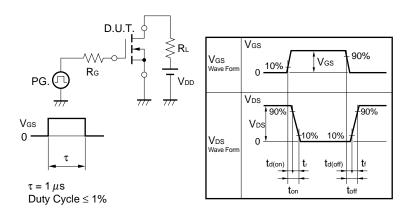
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#### **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

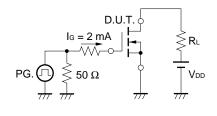
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	Vps = 20.0 V, Vgs = 0 V			1.0	μΑ
Gate Leakage Current	Igss	Vgs = ±12.0 V, Vps = 0 V			±10.0	μΑ
Gate Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10.0 V, I <sub>D</sub> = 1.0 mA	0.5	1.0	1.5	V
Forward Transfer Admittance Note	yfs	Vps = 10.0 V, Ip = 3.0 A	5			S
Drain to Source On-state Resistance Note	RDS(on)1	Vgs = 4.5 V, ID = 3.0 A	12.0	16.0	20.0	mΩ
	RDS(on)2	Vgs = 4.0 V, ID = 3.0 A	13.0	16.5	21.0	mΩ
	RDS(on)3	Vgs = 2.5 V, ID = 3.0 A	15.0	20.0	27.0	mΩ
Input Capacitance	Ciss	Vps = 10.0 V		720		pF
Output Capacitance	Coss	Vgs = 0 V		166		pF
Reverse Transfer Capacitance	Crss	f = 1.0 MHz		125		pF
Turn-on Delay Time	td(on)	VDD = 10.0 V, ID = 3.0 A		48		ns
Rise Time	tr	Vgs = 4.0 V		245		ns
Turn-off Delay Time	td(off)	$R_G = 10 \Omega$		315		ns
Fall Time	tf			305		ns
Total Gate Charge	QG	V <sub>DD</sub> = 16.0 V		8.0		nC
Gate to Source Charge	Qgs	ID = 6.0 A		1.7		nC
Gate to Drain Charge	Q <sub>GD</sub>	Vgs = 4.0 V		3.5		nC
Body Diode Forward Voltage Note	V <sub>F(S-D)</sub>	IF = 6.0 A, VGS = 0 V		0.8		V
Reverse Recovery Time	trr	IF = 6.0 A, VGS = 0 V		295		ns
Reverse Recovery Charge	Qrr	$di/dt = 50 A/\mu s$		450		nC

**Note** Pulsed: PW  $\leq$  350  $\mu$ s, Duty Cycle  $\leq$  2%

#### **TEST CIRCUIT 1 SWITCHING TIME**

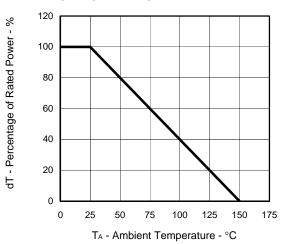


#### **TEST CIRCUIT 2 GATE CHARGE**

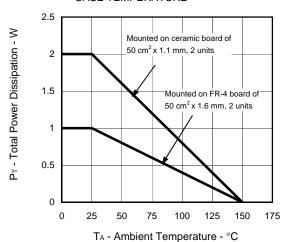


#### TYPICAL CHARACTERISTICS (TA = 25°C)

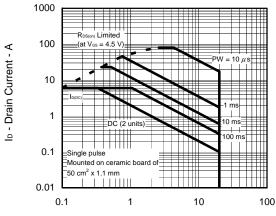
#### DERATING FACTOR OF FORWARD BIAS SAFE OPERATING AREA

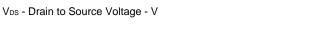


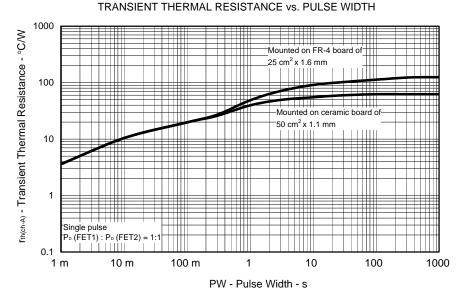
#### TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



#### FORWARD BIAS SAFE OPERATING AREA



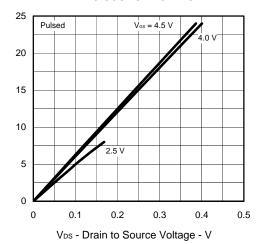




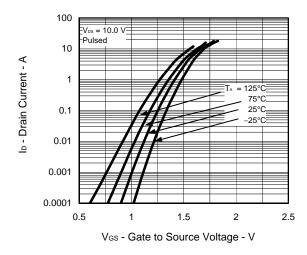
Ip - Drain Current - A

Ves(off) - Gate Cut-off Voltage - V

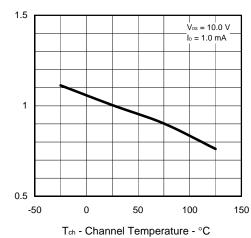
## DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



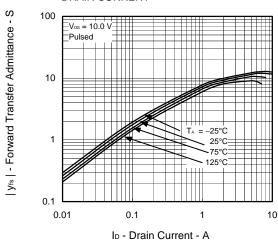
#### FORWARD TRANSFER CHARACTERISTICS



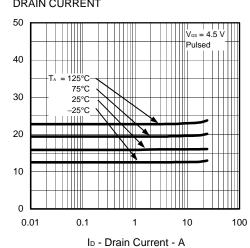
## GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



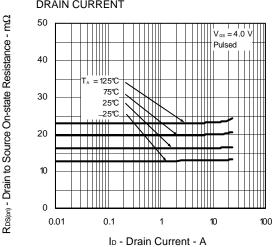
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



## DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

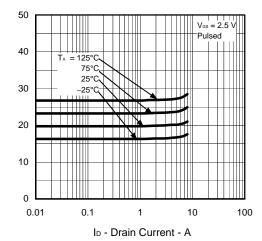


R<sub>DS(m)</sub> - Drain to Source On-state Resistance - mΩ

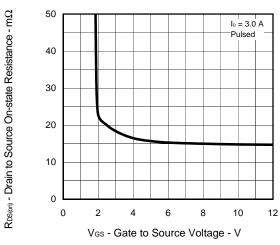
 $\mathsf{Rbs}_{(\varpi)}$  - Drain to Source On-state Resistance -  $m\Omega$ 

ta(on), tr, ta(off), tr - Switching Time - ns

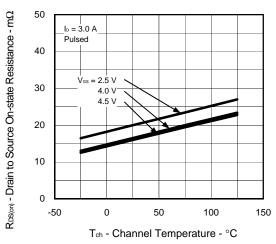
## DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



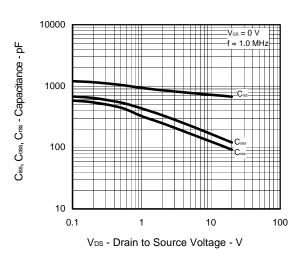
## DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



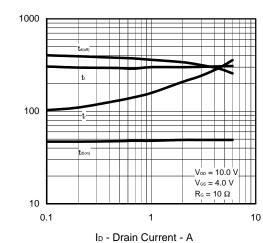
## DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



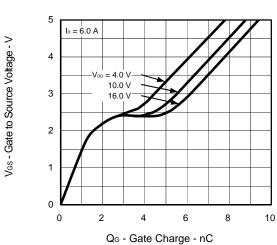
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



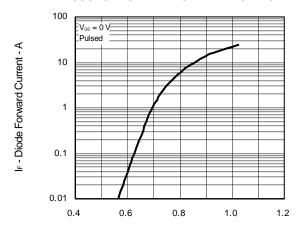
#### SWITCHING CHARACTERISTICS



DYNAMIC INPUT CHARACTERISTICS



#### SOURCE TO DRAIN FORWARD VOLTAGE



 $V_{\text{F(S-D)}}$  - Source to Drain Voltage - V

NEC  $\mu$  PA1870B

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